

Not so long time ago, let's say the last 15 years only one type of electronic assembly was used. This type of mounting is referred to as through-hole plating or through-hole mounting.

Despite a significant number of priorities in favor of surface mount of the printed circuit boards, it's hard to find a product which has no leads at all.

The main object of the pin assembly area is a soldering of DIP elements after the SMD of circuit boards of mixed type. Basically they are the power components, electromechanical relays, connectors, meaning those elements which have no analogues for the mounting surface.

SPE "Diskovi Systemy" provides high quality of electronic components through-hole mounting at an agreed time with the customer, using up to date solders, fluxes, soldering technology, cleaning and drying.